

Rev. V3

# GaAs WLAN Dual SPDT Switch 2.4 - 5.8 GHz

#### Features

- 802.11a & b/g, UNII, and Hiperlan Applications
- Optimized for 2.4 5.8 GHz WLAN
- Low Insertion Loss:
- 0.85 dB @ 2.4 GHz
- 1.1 dB @ 5.8 GHz
- High Isolation: 28 dB Typical
- Low Harmonics: <-63 dBc @ 20 dBm
- RoHS\* Compliant

### Description

The MASW-008206-000DIE is a WLAN GaAs pHEMT MMIC Dual SPDT switch. One SPDT (RF2) is optimized for 2.4 GHz WLAN and the other (RF5) is optimized for 5.8 GHz WLAN applications. Typical applications are for 802.11a and 802.11b/g PC card and access point applications.

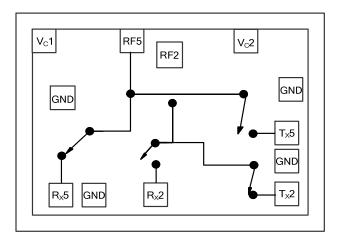
The MASW-008206-000DIE delivers high isolation, low insertion loss, and high linearity up to 5.8 GHz. This device is fabricated using a 0.5 micron gate length GaAs pHEMT process. The process features full passivation for performance and reliability.

### Ordering Information<sup>1</sup>

Part Number	Package
MASW-008206-000DIE	Separated Die on Grip Ring

1. Die quantity varies.

#### **Die Bond Pad Layout**



### **Die Bond Pad Configuration**

Pad No.	Name	Description
1	V <sub>c</sub> 1	Voltage Control 1
2	GND	Ground
3	R <sub>x</sub> 5	5 GHz R <sub>x</sub> Port
4	GND	Ground
5	R <sub>x</sub> 2	2.4 GHz R <sub>X</sub> Port
6	T <sub>x</sub> 2	2.4 GHz T <sub>X</sub> Port
7	GND	Ground
8	T <sub>x</sub> 5	5 GHz T <sub>X</sub> Port
9	GND	Ground
10	V <sub>c</sub> 2	Voltage Control 2
11	RF2	2.4 GHz Antenna Port
12	RF5	5 GHz Antenna Port

\* Restrictions on Hazardous Substances, European Union Directive 2002/95/EC.

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and/or prototype measurements. Commitment to develop is not guaranteed.

Commitment to produce in volume is not guaranteed.

1

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# Electrical Specifications<sup>2,3</sup>: $T_A = 25^{\circ}C$ , $Z_0 = 50 \Omega$ , $V_C = 0V / 3V$ , $P_{IN} = 0 \text{ dBm}$

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Insertion Loss	RF2 to Tx2/R <sub>x</sub> 2, 2.4 GHz RF5 to Tx5/Rx5, 5.0 GHz			0.85 1.1	1.0 1.2
Isolation	RF2 to Tx2/R <sub>x</sub> 2, 2.4 GHz RF5 to Tx5/Rx5, 5.0 GHz		25.5 21.0	30.0 25.0	_
Return Loss	DC - 6.0 GHz			15	
IP3	20 dBm Total Power, 1 MHz Spacing RF2 to Tx2/Rx2, 2.4 GHz RF5 to Tx5/Rx5, 4.9 GHz	dBm		54 55	
Input P1dB	RF2 to Tx2, 2.4-2.5 GHz RF5 to Tx5, 4.9-5.9 GHz			28 28	_
Harmonics	RF2 to Tx2, 2.4-2.5 GHz, 20 dBc RF5 to Tx5, 4.9-5.9 GHz, 20 dBc			-63 -67	_
Control Current	V <sub>C</sub>   = 3 V	μΑ	_	<1	10.0
T <sub>RISE</sub> / T <sub>FALL</sub>	10% - 90% RF, 90% - 10% RF	ns	-	22	—
T <sub>ON</sub> / T <sub>OFF</sub>	50% Control - 90% RF, 50% Control - 10% RF	ns	_	30	_

2. External blocking capacitors on all RF ports.

3. Electrical min/max are guaranteed in die form only.

### Absolute Maximum Ratings<sup>4,5</sup>

Parameter	Absolute Maximum
Input Power @ 3 V Control @ 5 V Control	+32 dBm +33 dBm
Operating Voltage	+8 volts
Operating Temperature	-40 <sup>°</sup> C to +85 <sup>°</sup> C
Storage Temperature	-65 <sup>°</sup> C to +150 <sup>°</sup> C

4. Exceeding any one or combination of these limits may cause permanent damage to this device.

5. M/A-COM Technology Solutions does not recommend sustained operation near these survivability limits.

and/or prototype measurements. Commitment to develop is not guaranteed.

#### Qualification

Qualified to M/A-COM specification REL-201, Process Flow –2.

#### Truth Table<sup>6,7,8</sup>

Control V <sub>c</sub> 1	Control V <sub>c</sub> 2	RF2 - T <sub>x</sub> 2 RF5 - R <sub>x</sub> 5	RF2 - R <sub>x</sub> 2 RF5 - T <sub>x</sub> 5
1	0	On	Off
0	1	Off	On

6. For positive voltage control, external DC blocking capacitors are required on all RF ports.

- 7. Differential voltage, V (state 1) V (state 0), must be
- +2.7 V minimum and must not exceed +5 V.
- 8.  $0 = 0 \pm 0.3$  V, 1 = +2.7 V to +5 V.

#### Handling Procedures

Please observe the following precautions to avoid damage:

#### **Static Sensitivity**

Gallium Arsenide Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these Class Zero (100 V) devices.

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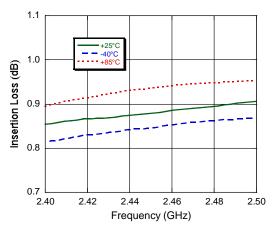
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<sup>2</sup> 

# GaAs WLAN Dual SPDT Switch 2.4 - 5.8 GHz

# Typical Performance Curves: 2.4-2.5 GHz (plots = chip on board assembly)

#### T<sub>x</sub> Insertion Loss



2.44

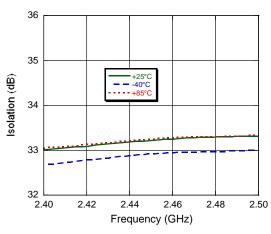
2.46

Frequency (GHz)

2.48

2.50





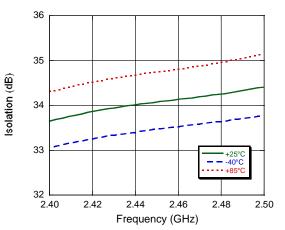


0.7

2.40

2.42

R<sub>x</sub> Insertion Loss



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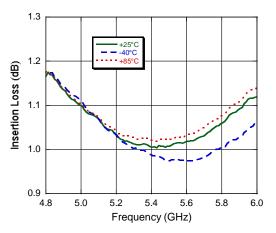




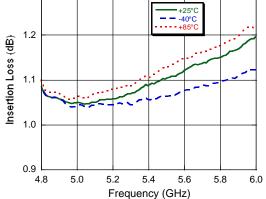
# GaAs WLAN Dual SPDT Switch 2.4 - 5.8 GHz

### Typical Performance Curves: 4.8-6.0 GHz (plots = chip on board assembly)

#### T<sub>x</sub> Insertion Loss

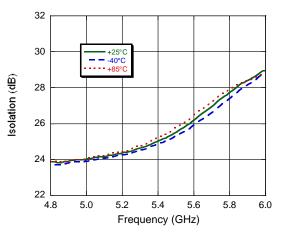


# R<sub>x</sub> Insertion Loss

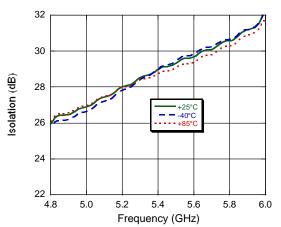


T<sub>x</sub> Isolation

4







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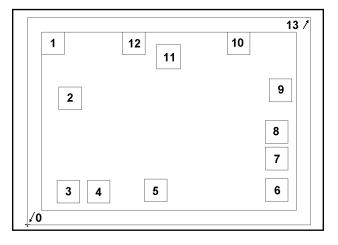




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### **Outline Drawing**

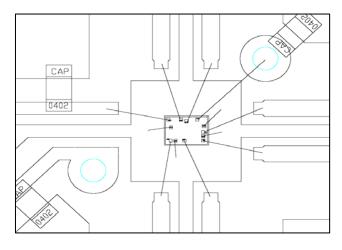


## Pad Configuration <sup>9</sup> Die Size: 890 x 650 µm (nominal) Die Thickness: 6 mils (nominal)

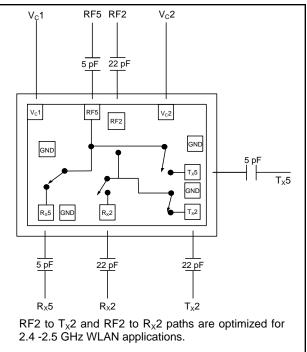
Pad No.	X (µm) nominal	Y (µm) nominal	Pad Size (µm)
0	0	0	Lower left edge of die
1	80.5	569.5	71 x 71
2	134.5	397	71 x 71
3	129	104	71 x 71
4	224	104	71 x 71
5	403.75	108	71 x 71
6	783.5	109	71 x 71
7	783.5	208	71 x 71
8	783.5	292	71 x 71
9	795.25	421.75	71 x 71
10	664	569.5	71 x 71
11	443	527	76 x 76
12	334.75	569.5	71 x 71
13	890	650	Upper right edge of die

9. All X,Y dimensions are at bond pad center.

### Chip mounted to PWB for testing purposes



### **Application Schematic**



RF5 to T<sub>x</sub>5 and RF5 to R<sub>x</sub>5 paths are optimized for 4.8 - 6.0 GHz WLAN applications.

- 5
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